# R66, Radial, 7.5 mm Lead Spacing, 50 – 630 VDC (Automotive Grade)



#### **Overview**

The R66 Series is constructed of metallized polyester film (wound or stacked technology) with radial leads of tinned wire. Radial leads are electrically welded to the contact metal layer on the ends of the capacitor winding. The capacitor is encapsulated with thermosetting resin in a box of material meeting the UL 94V-0 requirements.

Automotive grade devices meet the demanding Automotive Electronics Council's AEC-Q200 qualification requirements.

#### **Applications**

Typical applications include blocking, coupling, decoupling, bypassing and interference suppression in low voltage applications such as automotive. Not suitable for across-the-line application (see Suppressor Capacitors).

#### **Benefits**

Voltage range: 50 – 630 VDC

Capacitance range: 0.001 μF – 4.7 μF

· Lead Spacing: 7.5 mm

• Capacitance tolerance: ±5%, ±10%, ±20%

• Climatic category: 55/105/56

- Operating temperature range of -55°C to +105°C
- · RoHS compliance and lead-free terminations
- Tape and reel packaging in accordance with IEC 60286-2
- Self-healing
- Automotive grade (AEC-Q200)



## **Part Number System**

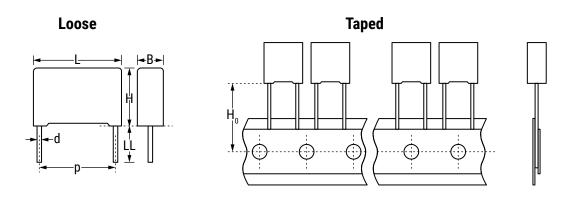
R66	E	D	3100	AA	7A	J
Series	Rated Voltage (VDC)	Length (mm)	Capacitance Code (pF)	Packaging	Internal Use	Capacitance Tolerance
Metallized Polyester	C = 50 D = 63 E = 100 I = 250 M = 400 P = 630	D = 7.5	The last three digits represent significant figures. First digit specifies the number of zeros to be added.	See Ordering Options Table	10 6A 7A	J = ±5% K = ±10% M = ±20%



# **Ordering Options Table**

Lead Spacing Nominal (mm)	Type of Leads and Packaging	LL Lead Length (mm)	Lead and Packaging Code
	Standard Lead and Packaging Options		
	Bulk (Bag) – Short Leads	4+2/-0	AA
	Ammo Pack	H <sub>0</sub> =18.5+/-0.5	DQ
	Other Lead and Packaging Options		
7.5	Tape & Reel (Standard Reel)	H <sub>0</sub> = 18.5+/-0.5	CK
	Bulk (Bag) – Short Leads	2.7+0.5/-0	JA
	Bulk (Bag) – Short Leads	3.5+0.5/-0	JB
	Bulk (Bag) – Short Leads	10+/-1	JC
	Bulk (Bag) – Short Leads	3.2+0.3/-0.2	JH
	Bulk (Bag) – Long Leads	17+1/-2	Z3

## **Dimensions - Millimeters**



p			В	Н		L		d	
Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance
7.5	+/-0.4	3.0	+0.1	8.0	+0.1	10.0	+0.2	0.5	+/-0.05
7.5	+/-0.4	4.0	+0.1	9.0	+0.1	10.0	+0.2	0.6	+/-0.05
7.5	+/-0.4	5.0	+0.1	10.5	+0.1	10.0	+0.2	0.6	+/-0.05
7.5	+/-0.4	6.0	+0.1	12.0	+0.1	10.5	+0.2	0.6	+/-0.05
	Note: See Ordering Options Table for lead length (LL/ $H_0$ ) options.								



## **Performance Characteristics**

Dielectric	Polyester film (polyethylene terephthalate).							
Plates	Metal layer deposited by evaporation under vacum.							
Winding	Non-inductive ty	Non-inductive type.						
Leads	Tinned wire.							
Protection	Plastic case, the UL94.	mosetting resin fill	ed. Box material is	solvent resistant ar	nd flame retardant a	ccording to		
Related Documents	IEC 60384-2							
Rated Voltage V <sub>R</sub> (VDC)	50	63	100	250	400	630		
Rated Voltage V <sub>R</sub> (VAC)	30	40	63	160	200	220		
Capacitance Range (μF)	0.68 - 4.7	0.33 - 3.3	0.068 - 1.5	0.022 - 0.33	0.0068 - 0.15	0.001 - 0.047		
Capacitance Values	E6 series (IEC 60	063) measured at 1	kHz and +20 ±1°C					
Capacitance Tolerance	±5%, ±10%, ±20%							
Operating Temperature Range	-55°C to +105°C hours. (stacked t		mperature of +125°	C is allowed for a m	aximum operating t	ime of 1,000		
Rated Temperature T <sub>R</sub>	+85°C							
Voltage Derating	Above +85°C DC and AC voltage derating is 1.25%/°C							
Climatic Category	55/105/56 IEC 60	55/105/56 IEC 60068-1						
	Storage time: ≤ 2	Storage time: ≤ 24 months from the date marked on the label package						
	Average relative	humidity per year ≤	70%					
Storage Conditions	RH ≤ 85% for 30 (	days randomly distr	ibuted throughout t	he year				
	Dew is absent							
	Temperature: -4	O to 80°C (see "Max	imum Humidity in S	Storage Conditions'	graph below)			
Test Voltage	1.6 x V <sub>R</sub> VDC for 2	2 seconds (betweer	n terminations) at +2	25°C ±5°C				
Capacitance Drift	Maximum 3% aft to 60%	er a 2 year storage	period at a tempera	ture of +10°C to +4	0°C and a relative h	umidity of 40%		
	Operational life >	200,000 hours						
Reliability (Reference MIL-HDBK-217)	Failure rate ≤ 2 F	Failure rate $\leq$ 2 FIT, T = +40°C, V = 0.5 x V <sub>R</sub>						
	Failure criteria: open or short circuit, cap. change > 10%, DF 2 times the catalog limits, IR < 0.005 x initial limit							
Maximum Pulse Steepness	dV/dt according to Table 1. For peak to peak voltages lower than rated voltage (Vpp $<$ V $_R$ ), the specified dv/dt can be multiplied by the factor V $_R$ /Vpp							
Temperature Coefficient	+400 (±200)ppm	/°C at 1 kHz						
Self Inductance (Lead Length ~ 2 mm)	Approximately 8	nH. Maximum 1nH	per 1 mm lead and	capacitor length.				

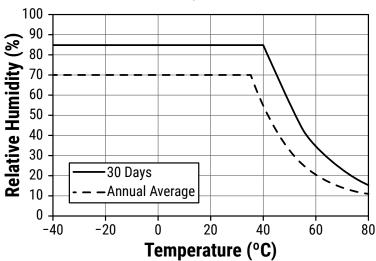


#### **Performance Characteristics cont'd**

	Maximum Values at 25°C ±5°C					
Discipation Factor tons	Frequency	For all Capacitance Values				
Dissipation Factor tanδ	1 kHz	1.0	0%			
	10 kHz	1.50%				
	Measured at +25°C ±5°C, according to IEC 60384-2					
	Minimum Values Between Terminals					
Insulation Resistance	Voltage Carge / Time	C ≤ 0.33 µF	C > 0.33 µF			
	50 VDC for V <sub>R</sub> ≤100 VDC 1 minute	≥3,750 MΩ (≥50,000 MΩ)*	≥ 1,250 MΩ • μF (≥5,000 MΩ • μF ) *			
	100 VDC for V <sub>R</sub> >100 VDC 1 minute	≥30,000 MΩ (≥50,000 MΩ)*				

<sup>\*</sup> typical value

## **Maximum Humidity in Storage Conditions**

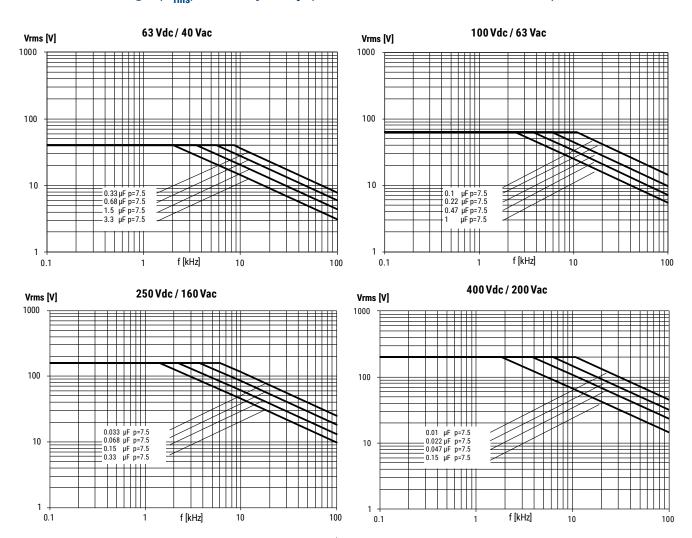


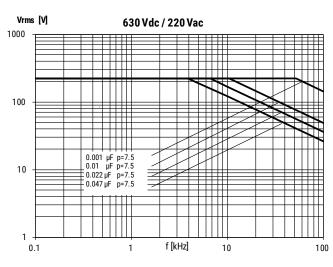
#### Qualification

Automotive Grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC-Q200, Stress Test Qualification for Passive Components. For additional information regarding the Automotive Electronics Council and AEC-Q200, please visit their website at www.aecouncil.com.



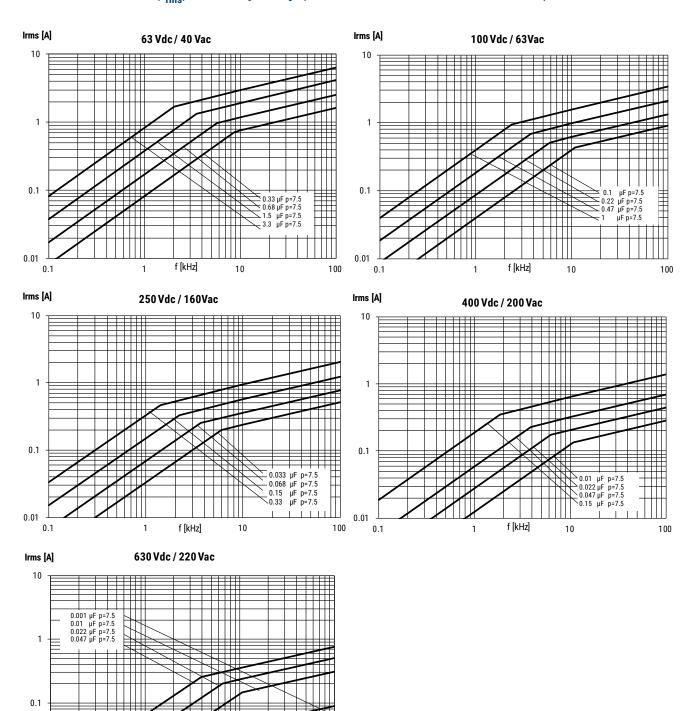
# Maximum Voltage ( $V_{rms}$ ) vs. Frequency (Sinusoidal Waveform/Th $\leq 40$ °C)







# Maximum Current ( $I_{rms}$ ) vs. Frequency (Sinusoidal Waveform/Th $\leq 40$ °C)



10

100

f [kHz]

0.01

0.1



#### **Environmental Test Data**

Damp Heat, Steady State Test	Test Cor	nditions:	Performances
	Temperature: Relative humidity (RH): Test duration:	+40°C ±2°C 93% ±2% 56 days	$\Delta$ C/C   ≤ 5%, $\Delta$ tan $\delta$ ≤ 0.005 at 1 kHz IR after test ≥ 50% of initial limit
<b>Endurance Test</b>	Test Conditions		Performances
	Temperature: Voltage applied: Test duration:	+105°C ±2°C 1.25 x V <sub>c</sub> 2,000 hours	$\Delta$ C/C   ≤ 5%, $\Delta$ tan $\delta$ ≤ 0.005 at 10 kHz for C ≤ 1 $\mu$ F $\Delta$ tan $\delta$ ≤ 0.003 at 1 kHz for C > 1 $\mu$ F IR after test ≥ 50% of initial limit
Resistance to Soldering Heat Test	Test Co	nditions	Performances
	Solder bath temperature: Dipping time (with heat screen):	260°C ±5°C 10 seconds ±1 second	$\Delta$ C/C   ≤ 2%, $\Delta$ tan $\delta$ ≤ 0.005 at 10 kHz for C ≤ 1 $\mu$ F $\Delta$ tan $\delta$ ≤ 0.003 at 1 kHz for C > 1 $\mu$ F IR after test ≥ initial limit

# **Environmental Compliance**

All KEMET MKT capacitors are RoHS Compliant.



## **Table 1 - Ratings & Part Number Reference**

		Capacitance	Dime	nsions i	in mm	Lead	dV/dt Maximum K		New KEMET	Legacy Part
VDC	VAC	Value (µF)	В	Н	L	Spacing	(V/ µs)	(V <sup>2</sup> /µs)	Part Number	Number
50	30	0.68	3.0	8.0	10.0	7.5	100	10000	66CD3680(1)6A(2)	R66CD3680(1)6A(2)
50	30	1.0	3.0	8.0	10.0	7.5	100	10000	66CD4100(1)6A(2)	R66CD4100(1)6A(2)
50	30	1.5	4.0	9.0	10.0	7.5	100	10000	66CD4150(1)6A(2)	R66CD4150(1)6A(2)
50	30	2.2	5.0	10.5	10.0	7.5	100	10000	66CD4220(1)6A(2)	R66CD4220(1)6A(2)
50	30	4.7	6.0	12.0	10.5	7.5	100	10000	66CD4470(1)6A(2)	R66CD4470(1)6A(2)
63	40	0.33	3.0	8.0	10.0	7.5	120	15120	66DD33330(1)7A(2)	R66DD33330(1)7A(2)
63	40	0.47	3.0	8.0	10.0	7.5	120	15120	66DD3470(1)6A(2)	R66DD3470(1)6A(2)
63	40	0.68	4.0	9.0	10.0	7.5	120	15120	66DD3680(1)7A(2)	R66DD3680(1)7A(2)
63	40	1.0	4.0	9.0	10.0	7.5	120	15120	66DD4100(1)7A(2)	R66DD4100(1)7A(2)
63	40	1.5	5.0	10.5	10.0	7.5	120	15120	66DD4150(1)7A(2)	R66DD4150(1)7A(2)
63	40	2.2	6.0	12.0	10.5	7.5	120	15120	66DD4220(1)6A(2)	R66DD4220(1)6A(2)
63	40	3.3	6.0	12.0	10.5	7.5	120	15120	66DD4330(1)6A(2)	R66DD4330(1)6A(2)
100	63	0.068	3.0	8.0	10.0	7.5	150	30000	66ED2680(1)7A(2)	R66ED2680(1)7A(2)
100	63	0.10	3.0	8.0	10.0	7.5	150	30000	66ED3100(1)7A(2)	R66ED3100(1)7A(2)
100	63	0.15	3.0	8.0	10.0	7.5	150	30000	66ED3150(1)7A(2)	R66ED3150(1)7A(2)
100	63	0.22	3.0	8.0	10.0	7.5	150	30000	66ED3220(1)7A(2)	R66ED3220(1)7A(2)
100	63	0.33 0.47	4.0	9.0	10.0	7.5 7.5	150 150	30000	66ED3330(1)7A(2)	R66ED3330(1)7A(2)
100	63	0.47	4.0	9.0	10.0	7.5 7.5	150	30000	66ED3470(1)7A(2)	R66ED3470(1)7A(2)
100 100	63 63	1.0	4.0 5.0	9.0 10.5	10.0 10.0	7.5	150	30000 30000	66ED3680(1)7A(2) 66ED4100(1)7A(2)	R66ED3680(1)7A(2) R66ED4100(1)7A(2)
100	63	1.5	6.0	12.0	10.0	7.5	150	30000	66ED4150(1)6A(2)	R66ED4150(1)6A(2)
250	160	0.022	3.0	8.0	10.5	7.5	200	100000	` ' ' ' '	` ' ' '
250	160	0.022	3.0	8.0	10.0	7.5	200	100000	66ID2220(1)7A(2) 66ID2330(1)7A(2)	R66ID2220(1)7A(2) R66ID2330(1)7A(2)
250	160	0.033	3.0	8.0	10.0	7.5	200	100000	66ID2470(1)7A(2)	R66ID2470(1)7A(2)
250	160	0.068	3.0	8.0	10.0	7.5	200	100000	66ID2680(1)6A(2)	R66ID2680(1)6A(2)
250	160	0.10	4.0	9.0	10.0	7.5	200	100000	66ID3100(1)7A(2)	R66ID3100(1)7A(2)
250	160	0.15	4.0	9.0	10.0	7.5	200	100000	66ID3150(1)7A(2)	R66ID3150(1)7A(2)
250	160	0.22	5.0	10.5	10.0	7.5	200	100000	66ID3220(1)7A(2)	R66ID3220(1)7A(2)
250	160	0.33	6.0	12.0	10.5	7.5	200	100000	66ID3330(1)6A(2)	R66ID3330(1)6A(2)
400	200	0.0068	3.0	8.0	10.0	7.5	275	220000	66MD1680(1)7A(2)	R66MD1680(1)7A(2)
400	200	0.010	3.0	8.0	10.0	7.5	275	220000	66MD2100(1)7A(2)	R66MD2100(1)7A(2)
400	200	0.015	3.0	8.0	10.0	7.5	275	220000	66MD2150(1)7A(2)	R66MD2150(1)7A(2)
400	200	0.022	3.0	8.0	10.0	7.5	275	220000	66MD2220(1)6A(2)	R66MD2220(1)6A(2)
400	200	0.033	4.0	9.0	10.0	7.5	275	220000	66MD2330(1)7A(2)	R66MD2330(1)7A(2)
400	200	0.047	4.0	9.0	10.0	7.5	275	220000	66MD2470(1)7A(2)	R66MD2470(1)7A(2)
400	200	0.068	5.0	10.5	10.0	7.5	275	220000	66MD2680(1)7A(2)	R66MD2680(1)7A(2)
400	200	0.10	6.0	12.0	10.5	7.5	275	220000	66MD3100(1)6A(2)	R66MD3100(1)6A(2)
400	200	0.15	6.0	12.0	10.5	7.5	275	220000	66MD3150(1)6A(2)	R66MD3150(1)6A(2)
630	220	0.0010	3.0	8.0	10.0	7.5	40	50400	66PD1100(1)10(2)	R66PD1100(1)10(2)
630	220	0.0015	3.0	8.0	10.0	7.5	40	50400	66PD1150(1)10(2)	R66PD1150(1)10(2)
630	220	0.0022	3.0	8.0	10.0	7.5	40	50400	66PD1220(1)10(2)	R66PD1220(1)10(2)
630	220	0.0033	3.0	8.0	10.0	7.5	40	50400	66PD1330(1)10(2)	R66PD1330(1)10(2)
630	220	0.0047	3.0	8.0	10.0	7.5	40	50400	66PD1470(1)10(2)	R66PD1470(1)10(2)
630	220	0.0068	4.0	9.0	10.0	7.5	40	50400	66PD1680(1)10(2)	R66PD1680(1)10(2)
630	220	0.010	4.0	9.0	10.0	7.5	300	378000	66PD2100(1)7A(2)	R66PD2100(1)7A(2)
630	220	0.015	4.0	9.0	10.0	7.5	300	378000	66PD2150(1)7A(2)	R66PD2150(1)7A(2)
630	220	0.022	5.0	10.5	10.0	7.5	300	378000	66PD2220(1)7A(2)	R66PD2220(1)7A(2)
630	220	0.033	6.0	12.0	10.5	7.5	300	378000	66PD2330(1)6A(2)	R66PD2330(1)6A(2)
630	220	0.047	6.0	12.0	10.5	7.5	300	378000	66PD2470(1)6A(2)	R66PD2470(1)6A(2)
VDC	VAC	Capacitance Value (µF)	B (mm)	H (mm)	L (mm)	Lead Spacing	dV/dt (V/μs)	Max K <sub>0</sub> (V²/μs)	New KEMET Part Number	Legacy Part Number

 $<sup>(1) \</sup> Insert\ lead\ and\ packaging\ code.\ See\ Ordering\ Options\ Table\ for\ available\ options.$ 

**Bold denotes wound capacitor technology** 

<sup>(2)</sup> J = 5%, K = 10%, M = 20%



### **Soldering Process**

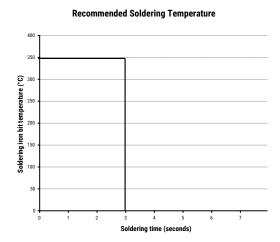
The implementation of the RoHS directive has resulted in the selection of SnAgCu (SAC) alloys or SnCu alloys as primary solder. This has increased the liquidus temperature from that of 183°C for SnPb eutectic alloy to 217 – 221°C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 – 170°C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 mm to 15 mm), and great care has to be taken during soldering. The recommended solder profiles from KEMET should be used. Please consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. Please see Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above the recommended limits may result to degradation or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert through-hole parts after the curing of surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Please allow time for the capacitor surface temperature to return to a normal temperature before the second soldering cycle.

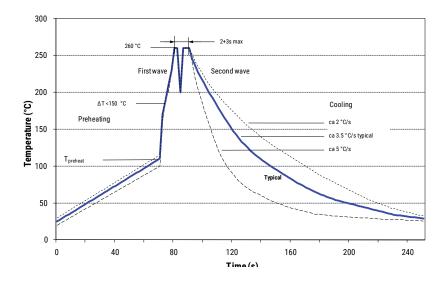
#### **Manual Soldering Recommendations**

Following is the recommendation for manual soldering with a soldering iron.



The soldering iron tip temperature should be set at 350°C (+10°C maximum) with the soldering duration not to exceed more than 3 seconds.

#### **Wave Soldering Recommendations**





#### **Soldering Process cont'd**

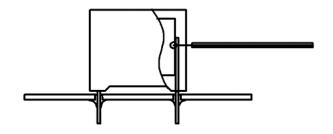
#### **Wave Soldering Recommendations cont'd**

1. The table indicates the maximum set-up temperature of the soldering process Figure 1

Dielectric		imum Pre emperatu	Maxi Peak So Tempe	oldering	
Film Material	Capacitor Pitch ≤ 10 mm	Capacitor Pitch = 15 mm	Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm
Polyester	130°C	130°C	130°C	270°C	270°C
Polypropylene	100°C	110°C	130°C	260°C	270°C
Paper	130°C	130°C	140°C	270°C	270°C
Polyphenylene Sulphide	150°C	150°C	160°C	270°C	270°C

2. The maximum temperature measured inside the capacitor: Set the temperature so that inside the element the maximum temperature is below the limit:

Dielectric Film Material	Maximum temperature measured inside the element
Polyester	160°C
Polypropylene	110°C
Paper	160°C
Polyphenylene Sulphide	160°C



Temperature monitored inside the capacitor.

#### **Selective Soldering Recommendations**

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as in normal flow soldering without touching the solder. When the board is over the bath, it is stopped and pre-designed solder pots are lifted from the bath with molten solder only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document, however, instead of two baths, there is only one bath with a time from 3 to 10 seconds. In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts are not overheated.



# Marking

- KEMET's logo
- Capacitance
- · Capacitance tolerance
- Rated DC voltage

# **Packaging Quantities**

Lead Spacing	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Bulk Long Leads	Standard Reel 355 mm	Ammo Taped
	3.0	8.0	10.0	1,500	1,750	2,100	2,800
7.5	4.0	9.0	10.0	2,000	1,500	1,500	2,100
7.5	5.0	10.5	10.0	1,500	1,000	1,200	1,600
	6.0	12.0	10.5	1,000	800	1,000	1,350



## **Lead Taping & Packaging (IEC 60286-2)**

Figure 1 - Lead Space 5 & 7.5 mm

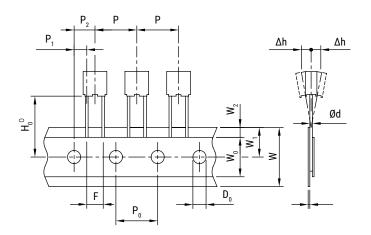
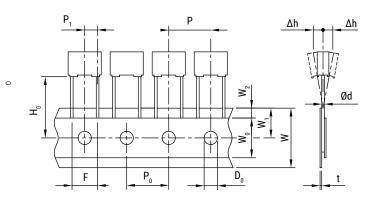


Figure 2 - Lead Space 7.5 mm



			Dimensi	ons (mm)	
Description	Symbol	l			
2 coonpaion	Cymbo.	5	7.5	7.5	Tolerance
		Figure 1	Figure 1	Figure 2	
Lead wire diameter	d	0.5 - 0.6	0.5 - 0.6	0.5 - 0.6	±0.05
Taping lead space	Р	12.7	12.7	12.7	±1
Feed hole lead space	$P_{\scriptscriptstyle{0}}$	12.7	12.7	12.7	±0.2*
Centering of the lead wire	P <sub>1</sub>	3.85	2.6	3.75	±0.7
Centering of the body	P <sub>2</sub>	6.35	6.35		±1.3
Lead spacing	F	5	7.5	7.5	+0.6 -0.1
Component alignment	Δh	0	0	0	±2
Height of component from tape center	H <sub>0</sub> **	18.5	18.5	18.5	±0.5
Carrier tape width	W	18	18	18	+1 -0.5
Hold down tape width	W <sub>o</sub>	6	6	6	Minimum
Hole position	W <sub>1</sub>	9	9	9	±0.5
Hold down tape position	W <sub>2</sub>	3	3	3	Maximum
Feed hole diameter	D <sub>o</sub>	4	4	4	±0.2
Tape thickness	t	0.7	0.7	0.7	±0.2

<sup>\*</sup>Maximum 1 mm on 20 lead spaces.

For orders of capacitors with lead space = 7.5 mm, please specify the requested version (Figure 1 or Figure 2).

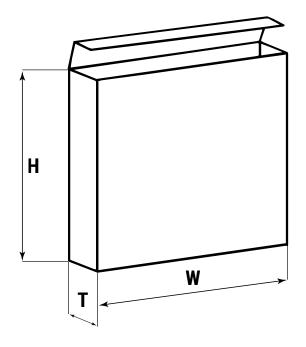
<sup>\*\*</sup> $H_0$  = 16.5 mm is available upon request.



# **Ammo Specifications**

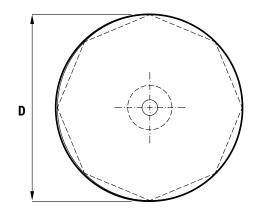
Dimensions in mm						
H W T						
360 * 340 59						

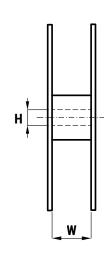
<sup>\*</sup> Lower dimension available upon request (maximum 295 mm)



# **Reel Specifications**

Dimensions in mm		
D	Н	W
355	30	55 maximum







#### **KEMET Electronics Corporation Sales Offices**

For a complete list of our global sales offices, please visit www.kemet.com/sales.

#### **Disclaimer**

All product specifications, statements, information and data (collectively, the "Information") in this datasheet are subject to change. The customer is responsible for checking and verifying the extent to which the Information contained in this publication is applicable to an order at the time the order is placed.

All Information given herein is believed to be accurate and reliable, but it is presented without guarantee, warranty, or responsibility of any kind, expressed or implied.

Statements of suitability for certain applications are based on KEMET Electronics Corporation's ("KEMET") knowledge of typical operating conditions for such applications, but are not intended to constitute – and KEMET specifically disclaims – any warranty concerning suitability for a specific customer application or use. The Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by KEMET with reference to the use of KEMET's products is given gratis, and KEMET assumes no obligation or liability for the advice given or results obtained.

Although KEMET designs and manufactures its products to the most stringent quality and safety standards, given the current state of the art, isolated component failures may still occur. Accordingly, customer applications which require a high degree of reliability or safety should employ suitable designs or other safeguards (such as installation of protective circuitry or redundancies) in order to ensure that the failure of an electrical component does not result in a risk of personal injury or property damage.

Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicted or that other measures may not be required.

## **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Film Capacitors category:

Click to view products by Kemet manufacturer:

Other Similar products are found below:

F339X134748MIP2T0 F450KG153J250ALH0J 750-1018 FKP1-1500160010P15 FKP1R031007D00JYSD FKP1R031507E00JYSD FKP1U024707E00KYSD 82DC4100CK60J 82EC1100DQ50K PFR5101J100J11L16.5TA18 PME261JB5220KR19T0 A451GK223M040A A561ED221M450A QXJ2E474KTPT QXL2B333KTPT R49AN347000A1K EEC2G505HQA406 B25668A6676A375 B25673A4282E140 BFC233868148 BFC2370GC222 C3B2AD44400B20K C4ASWBU3220A3EK CB027C0473J-- CB177I0184J-- CB182K0184J-- 23PW210 950CQW5H-F SBDC3470AA10J SCD105K122A3-22 2N3155 A571EH331M450A FKP1-2202KV5P15 FKS3-680040010P10 QXL2E473KTPT 445450-1 B25669A3996J375 46KI322000M1M 46KR415050M1K 4BSNBX4100ZBFJ MKP383510063JKP2T0 MKPY2-.02230020P15 MKT 1813-368-015 4055292001 46KN410000N1K EEC2E106HQA405 EEC2G205HQA402 EEC2G805HQA415 P409CP224M250AH470 82EC2150DQ50K